Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
    - Class Q Military
    - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)

    - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

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FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS251
3-STATE 1-of-8 Line Data Selector/Multiplexer

General Description

These data selectors/multiplexers contain full on-chip binary decoding to select one-of-eight data sources, and feature a strobe-controlled 3-STATE output. The strobe must be at a low logic level to enable these devices. The 3-STATE outputs permit direct connection to a common bus. When the strobe input is HIGH, both outputs are in a high-impedance state in which both the upper and lower transistors of each totem-pole output are OFF, and the output neither drives nor loads the bus significantly. When the strobe is LOW, the outputs are activated and operate as standard TTL totem-pole outputs.

To minimize the possibility that two outputs will attempt to take a common bus to opposite logic levels, the output control circuitry is designed so that the average output disable time is shorter than the average output enable time.

Features

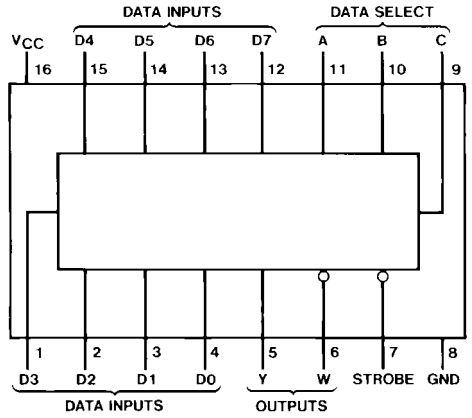
- 3-STATE version of DM74LS151
- Interface directly with system bus
- Perform parallel-to-serial conversion
- Permit multiplexing from N-lines to one line
- Complementary outputs provide true and inverted data
- Maximum number of common outputs: 129
- Typical propagation delay time (D to Y): 17 ns
- Typical power dissipation: 35 mW

Ordering Code:

Order Number	Package Number	Package Description
DM74LS251M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS251N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

Inputs				Outputs	
Select			Strobe	Y	W
C	B	A	S		
X	X	X	H	Z	Z
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

H = HIGH Logic Level
L = LOW Logic Level
X = Don't Care
Z = High Impedance (OFF)
D0, D1…D7 = The level of the respective D input

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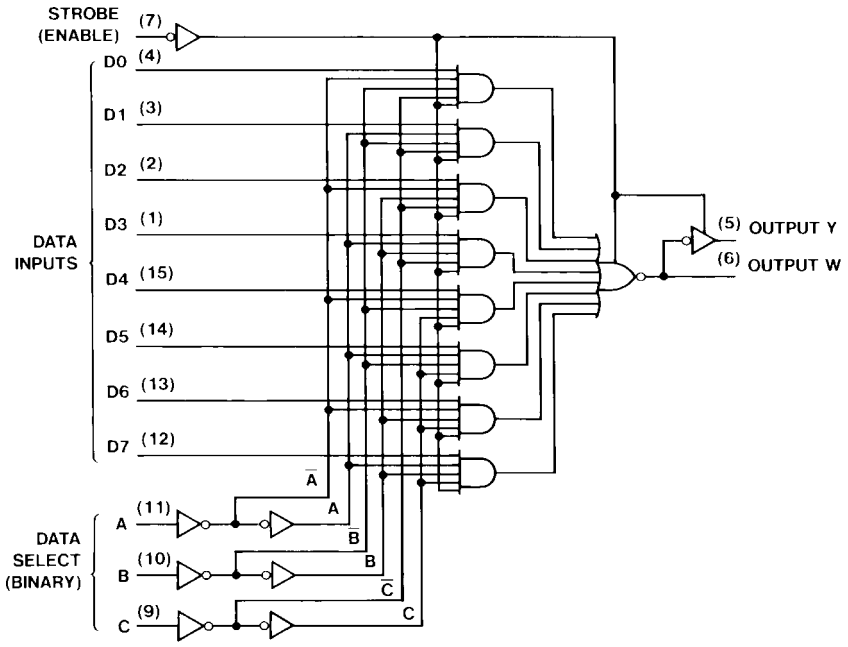
Logic Diagram



Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−2.6	mA
I_{OL}	LOW Level Output Current			24	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min	2.4	3.1		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 12 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.4	mA
I_{OZH}	Off-State Output Current with HIGH Level Output Voltage Applied	V_{CC} = Max, V_O = 2.7V V_{IH} = Min, V_{IL} = Max			20	µA
I_{OZL}	Off-State Output Current with LOW Level Output Voltage Applied	V_{CC} = Max, V_O = 0.4V V_{IH} = Min, V_{IL} = Max			−20	µA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CC1}	Supply Current	V_{CC} = Max (Note 4)		6.1	10	mA
I_{CC2}	Supply Current	V_{CC} = Max (Note 5)		7.1	12	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 4: I_{CC1} is measured with the outputs open, STROBE grounded, and all other inputs at 4.5V.

Note 5: I_{CC2} is measured with the outputs open and all inputs at 4.5V.

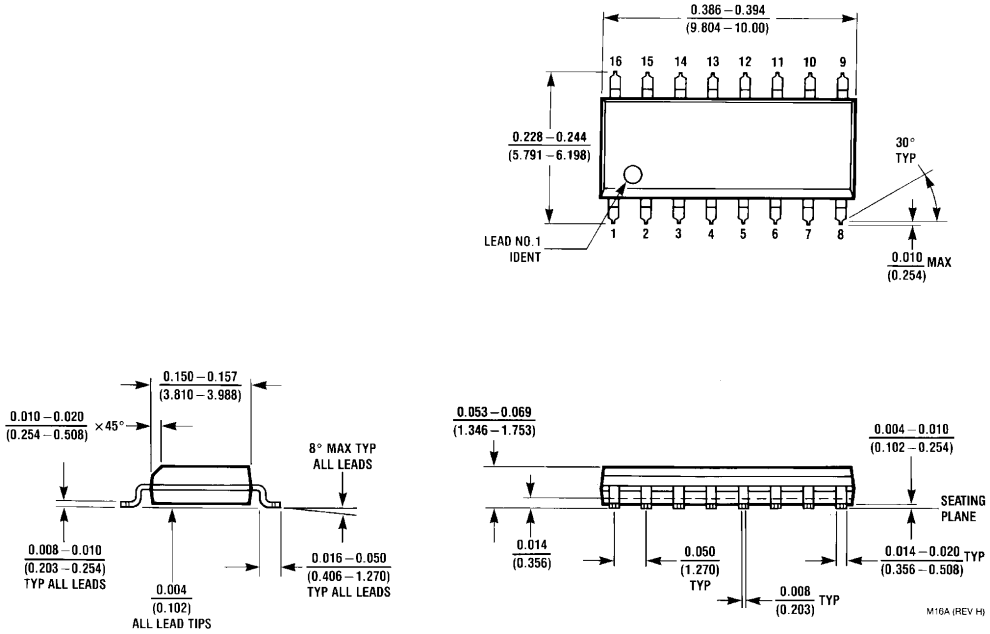
Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

Symbol	Parameter	From (Input) to (Output)	R_L = 667Ω				Units
			C_L = 45 pF		C_L = 150 pF		
			Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	A, B, C (4 Levels) to Y		45		53	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	A, B, C (4 Levels) to Y		45		53	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	A, B, C (3 Levels) to W		33		38	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	A, B, C (3 Levels) to W		33		42	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D to Y		28		35	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D to Y		28		38	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D to W		15		25	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D to W		15		25	ns
t_{PZH}	Output Enable Time to HIGH Level Output	Strobe to Y		45		60	ns
t_{PZL}	Output Enable Time to LOW Level Output	Strobe to Y		40		51	ns
t_{PHZ}	Output Disable Time from HIGH Level Output (Note 6)	Strobe to Y		45			ns
t_{PLZ}	Output Disable Time from LOW Level Output (Note 6)	Strobe to Y		25			ns
t_{PZH}	Output Enable Time to HIGH Level Output	Strobe to W		27		40	ns
t_{PZL}	Output Enable Time to LOW Level Output	Strobe to W		40		47	ns
t_{PHZ}	Output Disable Time from HIGH Level Output (Note 6)	Strobe to W		55			ns
t_{PLZ}	Output Disable Time from LOW Level Output (Note 6)	Strobe to W		25			ns

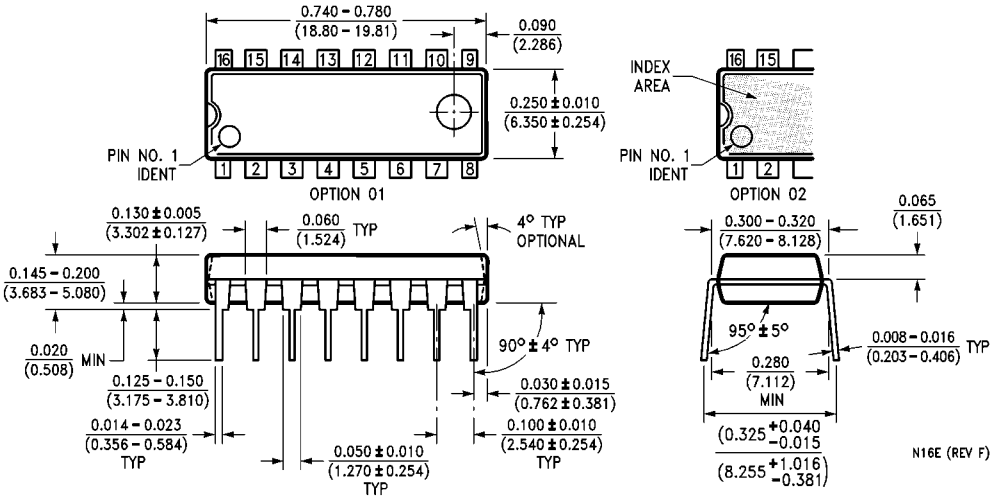
Note 6: C_L = 5 pF

Physical Dimensions inches (millimeters) unless otherwise noted



16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E

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